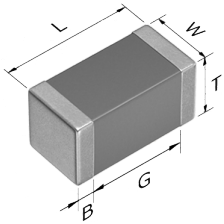


交货型号	C1608C0G1E822JT****	
用途		一般等级
特点	<div>General</div>	一般（～75V）
系列	C1608 [EIA 0603]	
状态		量产体制(新设计非推荐)



尺寸	
长度(L)	1.60mm ±0.10mm
宽度(W)	0.80mm ±0.10mm
厚度(T)	0.80mm ±0.10mm
端子宽度(B)	0.20mm Min.
端子间隔(G)	0.30mm Min.
推荐焊盘布局 (PA)	0.70mm to 1.00mm (Flow Soldering)
	0.60mm to 0.80mm (Reflow Soldering)
推荐焊盘布局 (PB)	0.80mm to 1.00mm (Flow Soldering)
	0.60mm to 0.80mm (Reflow Soldering)
推荐焊盘布局 (PC)	0.60mm to 0.80mm (Flow Soldering)
	0.60mm to 0.80mm (Reflow Soldering)

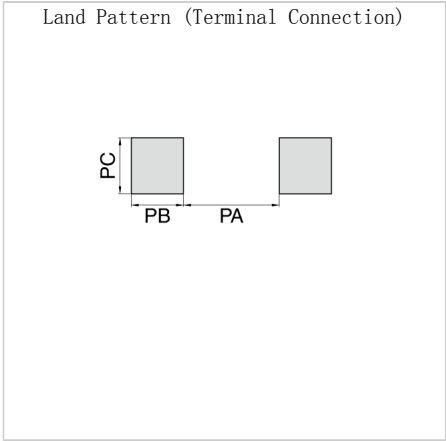
电气特性	
电容	8.2nF ±5%
额定电压	25VDC
温度特性	C0G (0±30ppm/° C)
Q (Min.)	1000
绝缘电阻 (Min.)	10000MΩ

其他	
焊接方法	流体
	回流
AEC-Q200	NO
包装形式	纸编带（180mm卷筒）
包装个数	4000pcs

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! All specifications are subject to change without notice.

特性图表 (这是参考数据，并不保证产品的特性。)

Associated Images



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